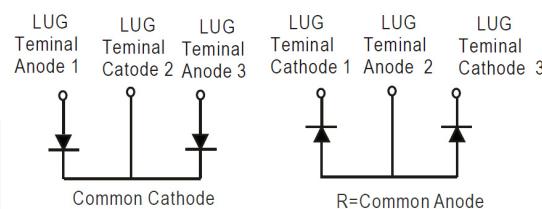


# Low $V_F$ Silicon Power Schottky Diode

 $V_{RRM} = 30 \text{ V}$ 
 $I_{F(AV)} = 600 \text{ A}$ 

## Features

- High Surge Capability
- Type 30 V  $V_{RRM}$
- Isolation Type Package
- Electrically Isolated Base Plate
- Not ESD Sensitive

**Heavy Three Tower Package**


**Maximum ratings, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified ("R" devices have leads reversed)**

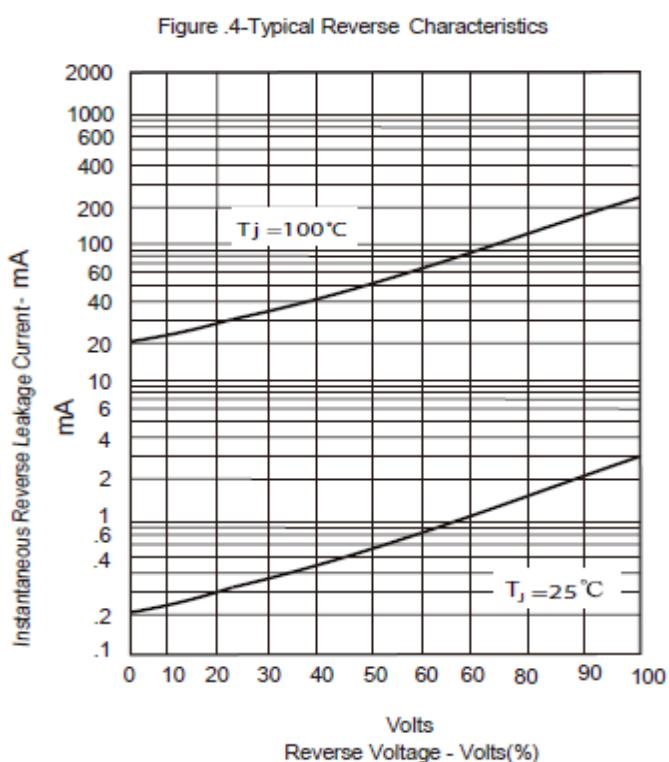
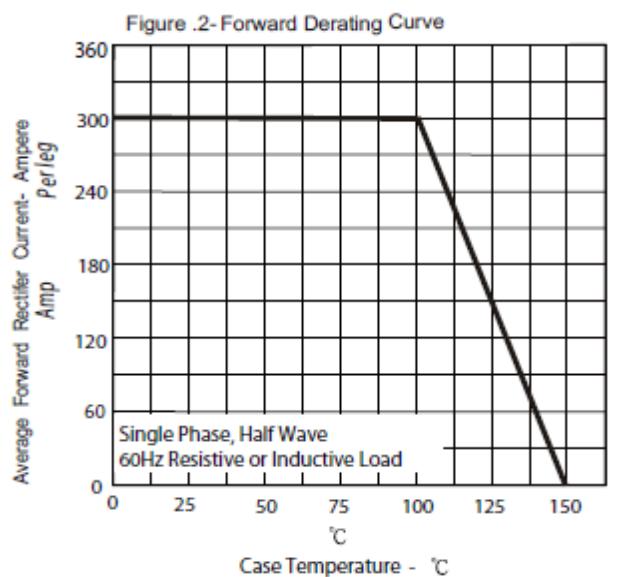
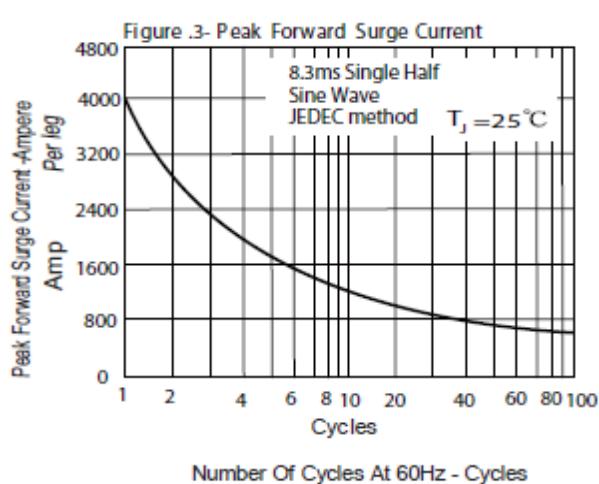
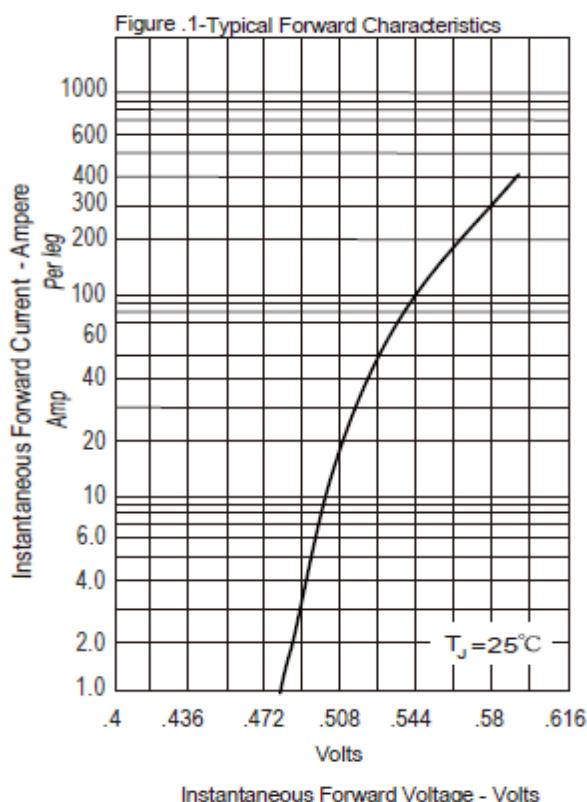
Parameter	Symbol	Conditions	MBRTA60030(R)L	Unit
Maximum recurrent peak reverse voltage	$V_{RRM}$		30	V
Maximum RMS voltage	$V_{RMS}$		21	V
Maximum DC blocking voltage	$V_{DC}$		30	V
Operating temperature	$T_j$		-55 to 150	°C
Storage temperature	$T_{stg}$		-55 to 150	°C

**Electrical characteristics, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified**

Parameter	Symbol	Conditions	MBRTA60030(R)L	Unit
Average forward current (per pkg)	$I_{F(AV)}$	$T_C = 100^\circ\text{C}$	600	A
Peak forward surge current (per leg)	$I_{FSM}$	$t_p = 8.3 \text{ ms, half sine}$	4000	A
Maximum instantaneous forward voltage (per leg)	$V_F$	$I_{FM} = 300 \text{ A, } T_j = 25^\circ\text{C}$	0.58	V
Maximum instantaneous reverse current at rated DC blocking voltage (per leg)	$I_R$	$T_j = 25^\circ\text{C}$ $T_j = 100^\circ\text{C}$	3 250	mA

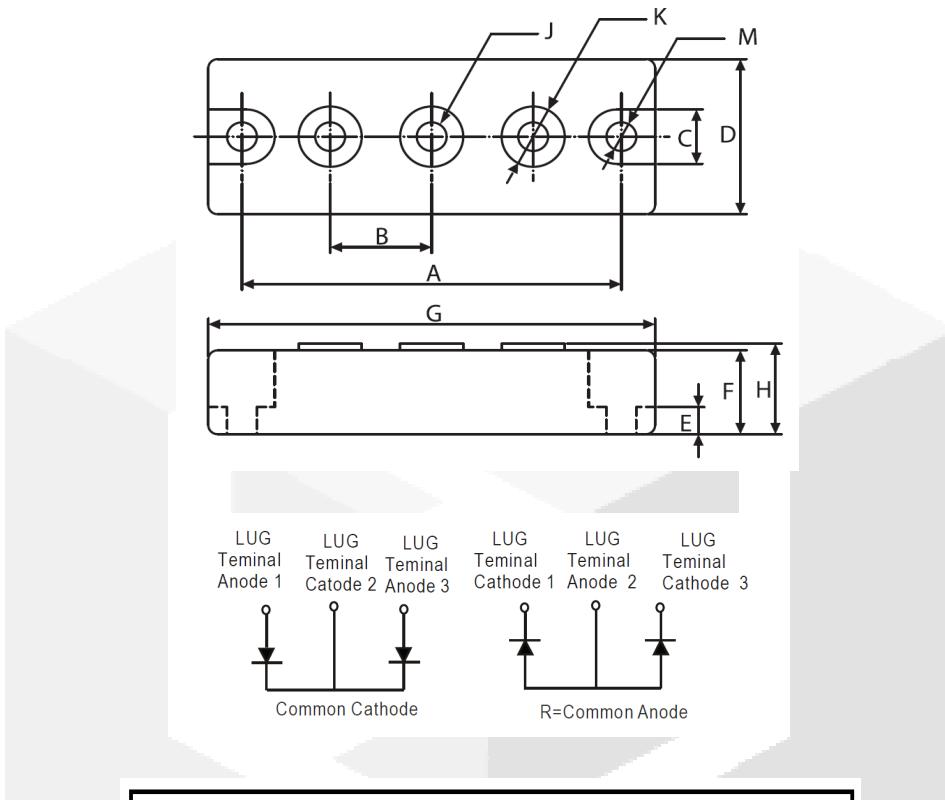
## Thermal characteristics

Maximum thermal resistance, junction - case (per leg)	$R_{\theta JC}$	0.28	°C/W
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#### **Package dimensions and terminal configuration**

Product is marked with part number and terminal configuration.



DIMENSIONS				
	INCHES		MM	
	MIN	MAX	MIN	MAX
A	3.150	NOM	80.01	NOM
B	.872	.892	22.15	22.65
C	.465	.479	11.82	12.18
D	1.337	1.356	33.95	34.45
E	.230	.234	5.84	6.16
F	.725	REF	18.42	REF
G	3.668	3.768	93.17	95.71
H	----	.791	---	20.10
J	1/4 - 20 UNC FULL			
K	.509	.538	12.92	13.68
M	.238	.258	6.05	6.55